

L Number	Hits	Search Text	DB	Time stamp
-	323	("174/267").CCLS.	USPAT	2002/01/16 18:16
-	8	((("5808874") or ("5821456") or ("6002590") or ("6108212") or ("6191952") or ("6265673") or ("6268568") or ("6284984")).PN.	USPAT	2002/01/22 09:33
-	1	("5373110").PN.	USPAT	2002/01/22 09:44
-	2	((("5266912") or ("4230385")).PN.	USPAT	2002/01/22 09:46
-	6	("4149764"   "4398235"   "4577214"   "4807019"   "4953060"   "5199879").PN.	USPAT	2002/01/22 09:55
-	717	("174/262").CCLS.	USPAT	2002/01/22 10:00
-	469	("174/250").CCLS.	USPAT	2002/01/22 10:00
-	4	((("6242078") or ("6245996") or ("6199273") or ("6207259")).PN.	USPAT	2002/01/22 10:26
-	0.	(organic adj binder) near5 (anisotropic\$ near2 etch\$)	USPAT	2002/01/22 11:16
-	19	(organic adj binder) near5 (anisotropic\$)	USPAT	2002/01/22 11:17
-	6088	anisotropically adj etch\$	USPAT	2002/01/22 11:20
-	2	(anisotropically adj etch\$) WITH epoxy	USPAT	2002/01/22 11:22
-	0	(anisotropically adj etch\$) WITH (thermosetting)	USPAT	2002/01/22 11:23
-	0	(anisotropically adj etch\$) with (thermosetting)	USPAT	2002/01/22 11:24
-	301	silicon near4 (thermosetting or (organic adj binder))	USPAT	2002/01/22 11:25
-	115	silicon near2 (thermosetting or (organic adj binder))	USPAT	2002/01/22 11:25
-	256	(melting adj point) near2 (epoxy)	USPAT	2002/01/22 12:29